

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR

# 2SK1954, 1954-Z

**Phase-out/Discontinued**

### SWITCHING

### N-CHANNEL POWER MOS FET

#### DESCRIPTION

The 2SK1954 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

#### FEATURES

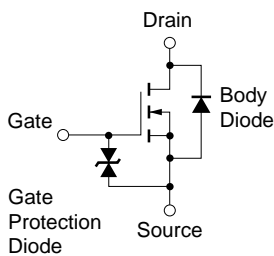
- Low On-state Resistance  
 $R_{DS(on)} = 0.65 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 2.0 \text{ A)}$
- Low  $C_{iss}$ :  $C_{iss} = 300 \text{ pF TYP.}$
- Built-in G-S Gate Protection Diode
- High Avalanche Capability Ratings

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Drain to Source Voltage	V <sub>DSS</sub>	180	V
Gate to Source Voltage	V <sub>GSS</sub>	±20	V
Drain Current (DC)	I <sub>D(DC)</sub>	±4.0	A
Drain Current (pulse) <sup>Note 1</sup>	I <sub>D(pulse)</sub>	±16	A
Total Power Dissipation (T <sub>c</sub> = 25°C)	P <sub>T1</sub>	20	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	1.0	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C
Single Avalanche Current <sup>Note 2</sup>	I <sub>AS</sub>	4.0	A
Single Avalanche Energy <sup>Note 2</sup>	E <sub>AS</sub>	44.3	mJ

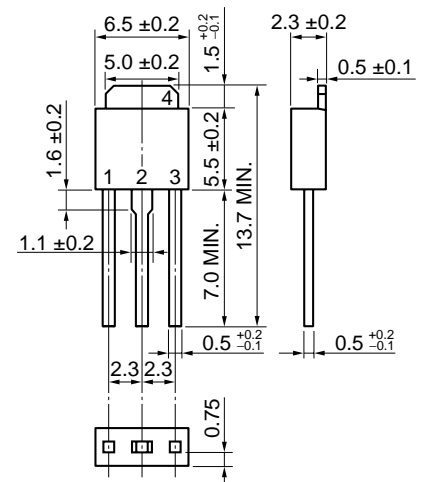
- Notes** 1.  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$   
 2. Starting  $T_{ch} = 25^\circ\text{C}$ ,  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \rightarrow 0 \text{ V}$

#### EQUIVALENT CIRCUIT

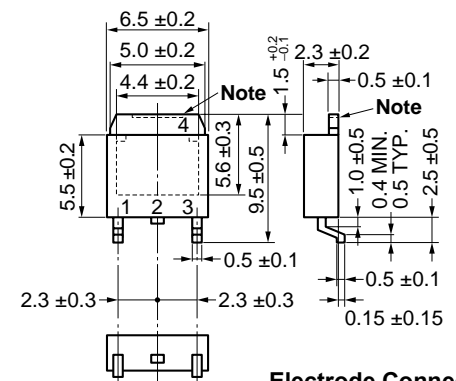


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#### PACKAGE DRAWINGS (Unit: mm)



<R> TO-251 (MP-3)



TO-252 (MP-3Z)

#### Electrode Connection

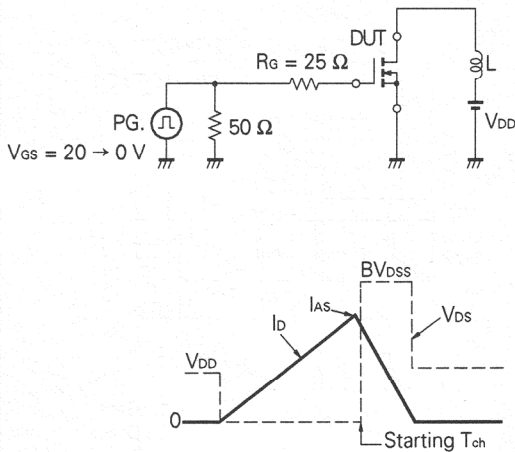
1. Gate
2. Drain
3. Source
4. Drain Fin

**Note** The depth of notch at the top of the fin is from 0 to 0.2 mm.

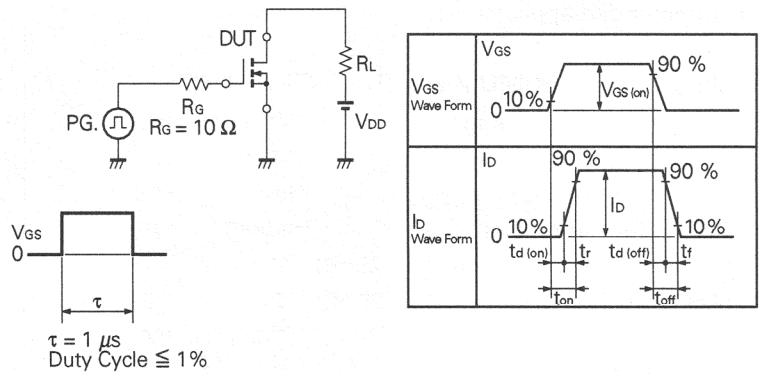
**ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C)**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R <sub>DS(on)</sub>		0.52	0.65	Ω	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.0 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.0		4.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	y <sub>fs</sub>	0.5			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.0 A
Drain Leakage Current	I <sub>DSS</sub>			100	μA	V <sub>DS</sub> = 180 V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	I <sub>GSS</sub>			±10	μA	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0
Input Capacitance	C <sub>iss</sub>		300		pF	V <sub>DS</sub> = 10 V V <sub>GS</sub> = 0 f = 1 MHz
Output Capacitance	C <sub>oss</sub>		170		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		50		pF	
Turn-On Delay Time	t <sub>d(on)</sub>		9		ns	V <sub>GS</sub> = 10 V V <sub>DD</sub> = 100 V I <sub>D</sub> = 2.0 A, R <sub>G</sub> = 10 Ω R <sub>L</sub> = 50 Ω
Rise Time	t <sub>r</sub>		10		ns	
Turn-Off Delay Time	t <sub>d(off)</sub>		28		ns	
Fall Time	t <sub>f</sub>		12		ns	
Total Gate Charge	Q <sub>G</sub>		10		nC	V <sub>GS</sub> = 10 V I <sub>D</sub> = 4.0 A V <sub>DD</sub> = 140 V
Gate to Source Charge	Q <sub>GS</sub>		2.3		nC	
Gate to Drain Charge	Q <sub>GD</sub>		4.7		nC	
Diode Forward Voltage	V <sub>F(S-D)</sub>		0.9		V	I <sub>F</sub> = 4.0 A, V <sub>GS</sub> = 0
Reverse Recovery Time	t <sub>rr</sub>		180		ns	I <sub>F</sub> = 4.0 A
Reverse Recovery Charge	Q <sub>rr</sub>		0.5		μC	di/dt = 50 A/μs

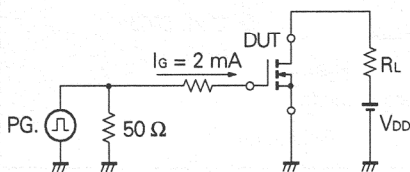
**Test Circuit 1: Avalanche Capability**



**Test Circuit 2: Switching Time**

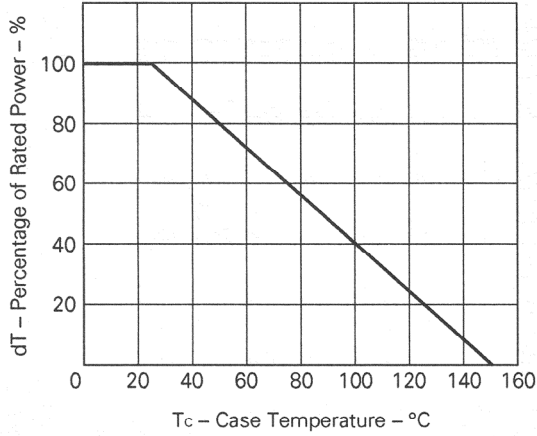


**Test Circuit 3: Gate Charge**

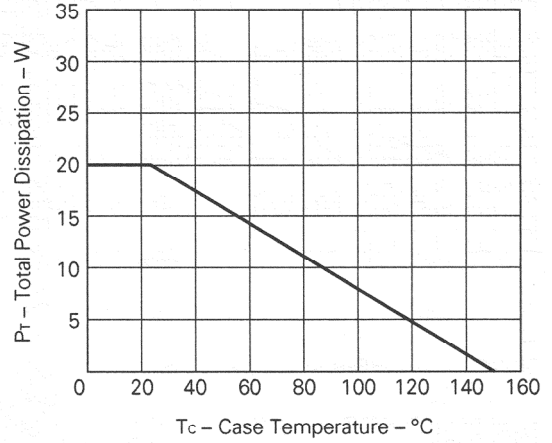


**TYPICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C)**

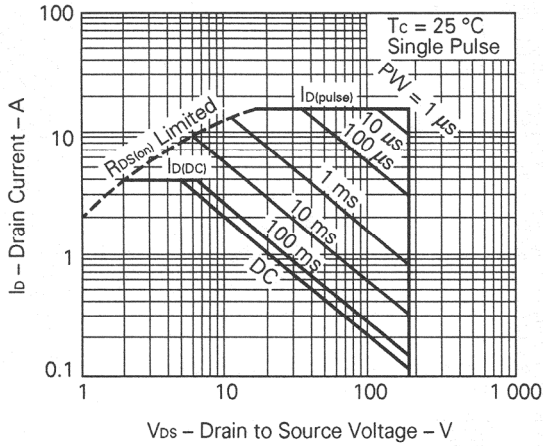
**DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA**



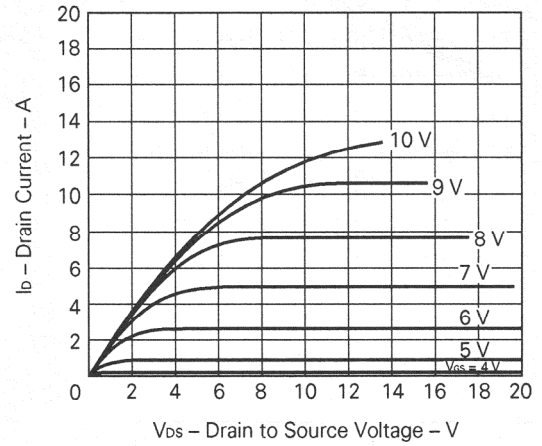
**TOTAL POWER DISSIPATION vs. CASE TEMPERATURE**



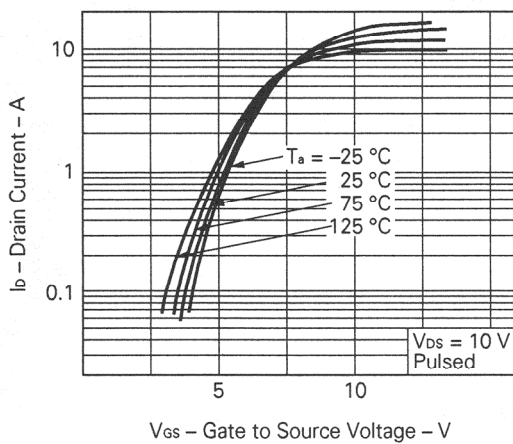
**FORWARD BIAS SAFE OPERATING AREA**

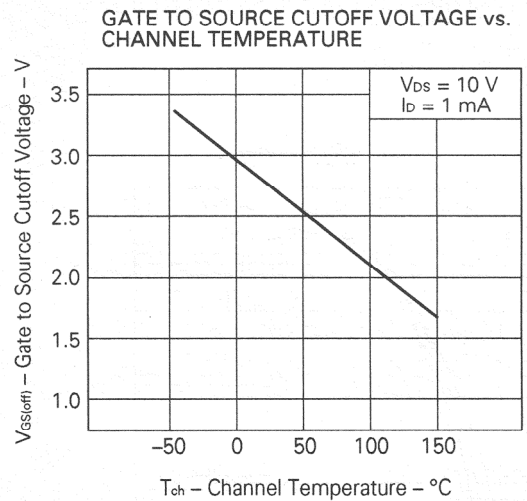
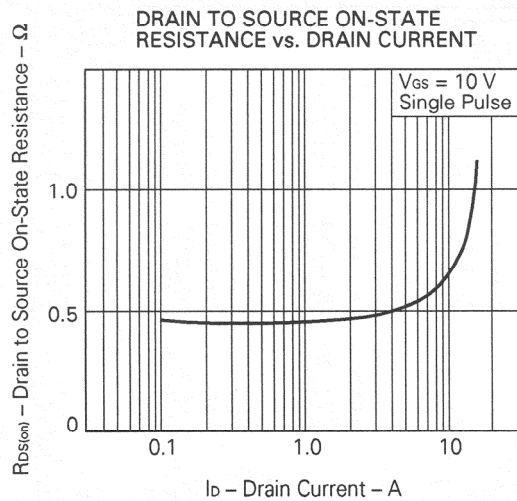
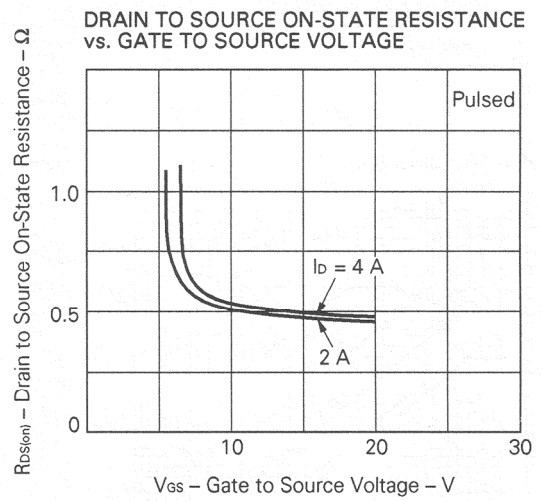
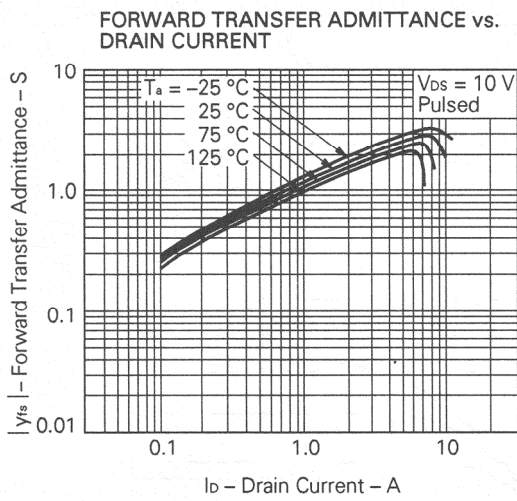
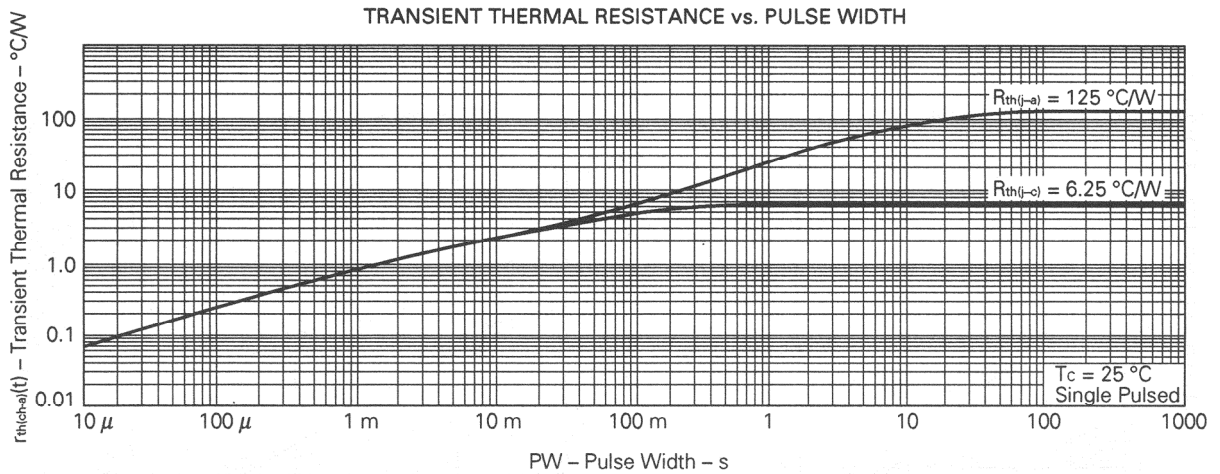


**DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE**

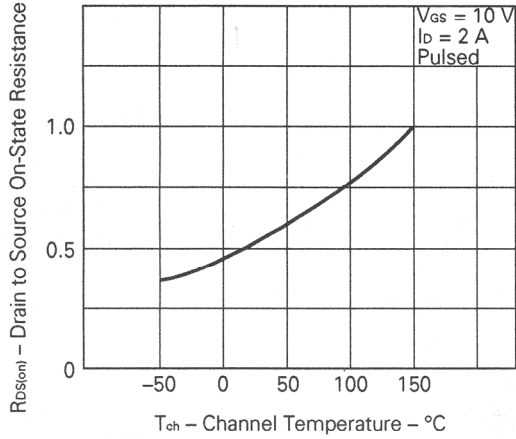


**TRANSFER CHARACTERISTICS**

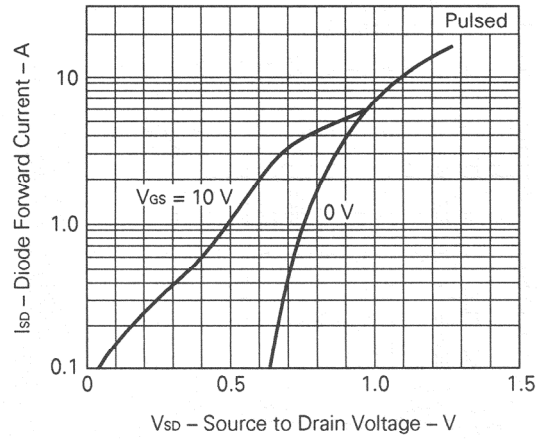




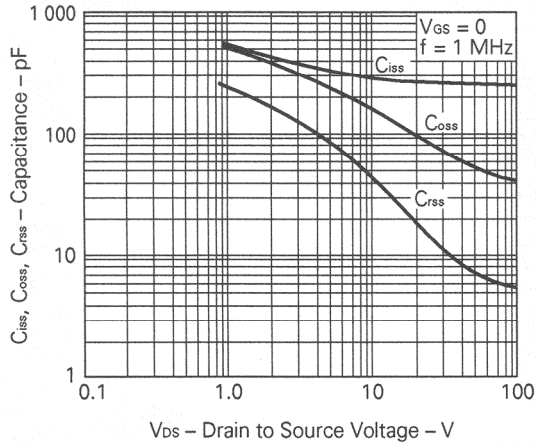
**DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE**



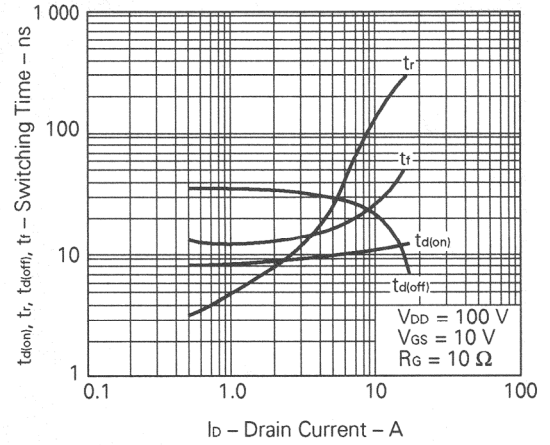
**SOURCE TO DRAIN DIODE FORWARD VOLTAGE**



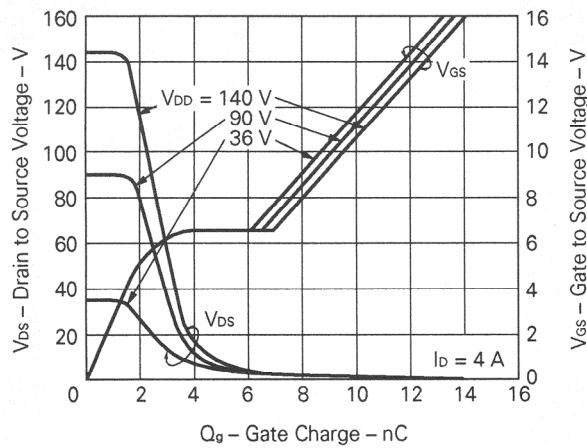
**CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE**



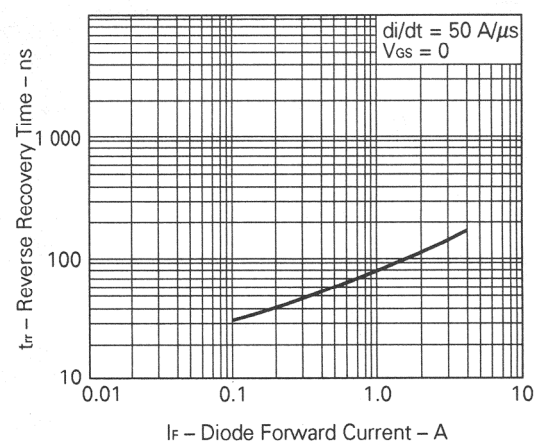
**SWITCHING CHARACTERISTICS**



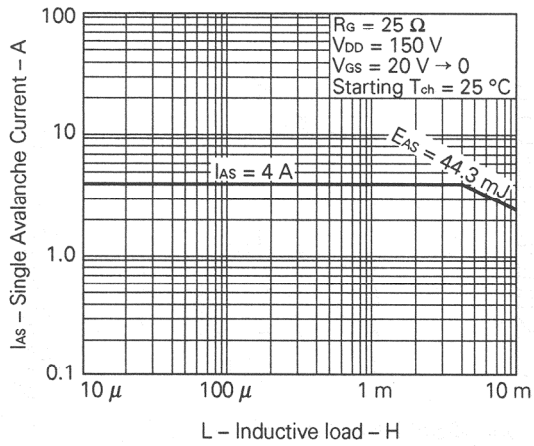
**DYNAMIC INPUT CHARACTERISTICS**



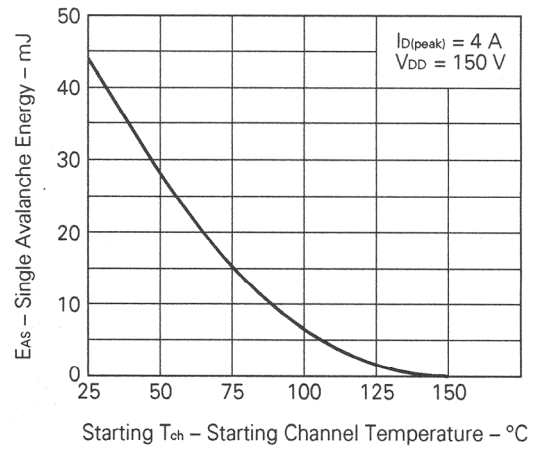
**REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT**



**SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD**



**SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE**





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